

# GaN Amplifier 48 V, 8 W

## 2.3 - 2.7 GHz



MAGB-102327-010B0P

Rev. V1

### Features

- Suitable for Linear and Saturated Applications
- Optimized for Cellular Base Station Applications
- Designed for Digital Predistortion Error Correction Systems
- High Terminal Impedances for Broadband Performance
- 48 V Operation
- 100 % RF Tested
- RoHS\* Compliant



4 mm DFN

### Description

The MAGB-102327-010B0P is a wideband GaN HEMT D-mode amplifier designed for base station applications and optimized for 2.3 - 2.7 GHz modulated signal operation. This device supports pulsed and linear operation with peak output levels to 8 W (39 dBm) in a 4x4mm DFN package.

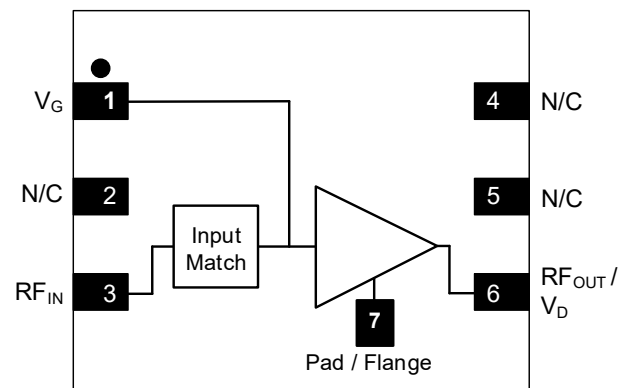
### Typical Performance

- $V_{DS} = 48\text{ V}$ ,  $I_{DQ} = 20\text{ mA}$ ,  $T_C = 25^\circ\text{C}$ . Measured under load-pull at 2.5 dB compression, 100  $\mu\text{s}$  pulse width, 10% duty cycle.

Frequency (GHz)	Output Power <sup>1</sup> (dBm)	Gain <sup>2</sup> (dB)	$\eta_D^2$ (%)
2.3	38.9	16.7	72.2
2.5	39.0	17.0	71.9
2.7	38.8	16.8	73.8

1. Load impedance tuned for maximum output power.
2. Load impedance tuned for maximum drain efficiency.

### Functional Schematic



### Pin Configuration<sup>3</sup>

Pin #	Pin Name	Function
1	$V_G$	Gate
2,4,5	N/C	No Connection
3	$RF_{IN}$	RF Input
6	$RF_{OUT} / V_D$	RF Output / Drain
7	Pad <sup>2</sup>	Ground / Source

3. The pad on the package bottom must be connected to RF, DC or thermal ground.

### Ordering Information

Part Number	Package
MAGB-102327-010B0P	Bulk Quantity
MAGB-102327-010BTP	Tape and Reel
MAGB-1B2327-010B0P	Class-AB Sample Board

<sup>1</sup> \* Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

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**RF Electrical Characteristics:  $T_{CASE} = 25^{\circ}C$ ,  $V_{DS} = 48V$ ,  $I_{DQ} = 20\text{ mA}$**

**Note: Performance in MACOM Single-ended Class-AB Evaluation Circuit, 50  $\Omega$  system**

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
Small Signal Gain	Pulsed <sup>4</sup> , 2.7 GHz	$G_{SS}$	-	17.2	-	dB
Saturated Output Power	Pulsed <sup>4</sup> , 2.7 GHz	$P_{SAT}$	-	38.4	-	dBm
Drain Efficiency at Saturation	Pulsed <sup>4</sup> , 2.7 GHz	$\eta_{SAT}$	-	72.2	-	%
AM/PM	Pulsed <sup>4</sup> , 2.7 GHz	$\phi$	-	-4	-	$^{\circ}$
Modulated Peak Power	WCDMA <sup>5</sup> , 2.7 GHz	$P_{2.5dB}^6$	-	38.7	-	dBm
Gain Flatness in 60MHz	WCDMA <sup>5</sup> , $P_{OUT} = 27\text{ dBm}$	$G_F$	-	0.3	-	dB
Gain Variation (-25 $^{\circ}C$ to +105 $^{\circ}C$ )	WCDMA <sup>5</sup> , 2.7 GHz, $P_{OUT} = 27\text{ dBm}$	$\Delta G$	-	0.02	-	dB/ $^{\circ}C$
Power Variation (-25 $^{\circ}C$ to +105 $^{\circ}C$ )	Pulsed <sup>4</sup> , 2.7 GHz	$\Delta P_{2.5dB}$	-	0.01	-	dBm/ $^{\circ}C$
Power Gain	WCDMA <sup>5</sup> , 2.7 GHz, $P_{OUT} = 27\text{ dBm}$	$G_P$	-	16.8	-	dB
Drain Efficiency	WCDMA <sup>5</sup> , 2.7 GHz, $P_{OUT} = 27\text{ dBm}$	$\eta$	-	23.3	-	%
Output CCDF @ 0.01%	WCDMA <sup>5</sup> , 2.7 GHz, $P_{OUT} = 27\text{ dBm}$	PAR	-	9.5	-	dB
Adjacent Channel Power	WCDMA <sup>5</sup> , 2.7 GHz, $P_{OUT} = 27\text{ dBm}$	ACP	-	-49	-	dBc
Input Return Loss	WCDMA <sup>5</sup> , 2.7 GHz, $P_{OUT} = 27\text{ dBm}$	IRL	-	-5	-	dB
Ruggedness: Output Mismatch	All phase angles	$\Psi$	VSWR = 10:1, No Device Damage			

**RF Electrical Characteristics:  $T_A = 25^{\circ}C$ ,  $V_{DS} = 48V$ ,  $I_{DQ} = 20\text{ mA}$**

**Note: Performance in MACOM Single-ended Class-AB Production Test Fixture, 50  $\Omega$  system**

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
Power Gain	WCDMA <sup>5</sup> , 2.7 GHz, $P_{OUT} = 31\text{ dBm}$	$G_P$	13.7	15.2	-	dB
Drain Efficiency	WCDMA <sup>5</sup> , 2.7 GHz, $P_{OUT} = 31\text{ dBm}$	$\eta$	26	31.3	-	%
Output CCDF @ 0.01%	WCDMA <sup>5</sup> , 2.7 GHz, $P_{OUT} = 31\text{ dBm}$	PAR	6.7	7.1	-	dB
Adjacent Channel Power	WCDMA <sup>5</sup> , 2.7 GHz, $P_{OUT} = 31\text{ dBm}$	ACP	-	-38	-35	dBc
Input Return Loss	WCDMA <sup>5</sup> , 2.7 GHz, $P_{OUT} = 31\text{ dBm}$	IRL	-	-5	-3	dB

**DC Electrical Characteristics:  $T_C = 25^{\circ}C$**

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
Drain-Source Leakage Current	$V_{GS} = -8\text{ V}$ , $V_{DS} = 130\text{ V}$	$I_{DLK}$	-	-	0.96	mA
Gate-Source Leakage Current	$V_{GS} = -8\text{ V}$ , $V_{DS} = 0\text{ V}$	$I_{GLK}$	-	-	-0.96	mA
Gate Threshold Voltage	$V_{DS} = 48\text{ V}$ , $I_D = 0.96\text{ mA}$	$V_T$	-2.6	-2.4	-	V
Gate Quiescent Voltage	$V_{DS} = 48\text{ V}$ , $I_D = 20\text{ mA}$	$V_{GSQ}$	-2.4	-2.0	-	V
On Resistance	$V_{GS} = 2\text{ V}$ , $I_D = 9.6\text{ mA}$	$R_{ON}$	-	4.3	-	$\Omega$
Maximum Drain Current	$V_{DS} = 7\text{ V}$ , pulse width 300 $\mu\text{s}$	$I_{D, MAX}$	-	0.6	-	A

4. Pulse details: 100  $\mu\text{s}$  pulse width, 1 ms period, 10% Duty Cycle

5. Modulated Signal: 3.84MHz, WCDMA 3GPP TM1 64 DPCH, 9.9dB PAR @ 0.01% CCDF

6.  $P_{2.5dB} = P_{OUT} + 7.5\text{ dB}$  where  $P_{OUT}$  is the average output power measured using a modulated signal<sup>5</sup> where the output PAR is compressed to 7.5 dB @ 0.01% probability CCDF.

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DC-0021807

### Absolute Maximum Ratings <sup>7,8,9,10,11</sup>

Parameter	Absolute Maximum
Drain Source Voltage, $V_{DS}$	130 V
Gate Source Voltage, $V_{GS}$	-10 to 3 V
Gate Current, $I_G$	1.92 mA
Storage Temperature Range	-65°C to +150°C
Case Operating Temperature Range	-40°C to +120°C
Channel Operating Temperature Range, $T_{CH}$	-40°C to +210°C
Absolute Maximum Channel Temperature	+225°C

7. Exceeding any one or combination of these limits may cause permanent damage to this device.
8. MACOM does not recommend sustained operation above maximum operating conditions.
9. Operating at drain source voltage  $V_{DS} < 55$  V will ensure  $MTTF > 4 \times 10^6$  hours.
10. Operating at nominal conditions with  $T_{CH} \leq 210^\circ\text{C}$  will ensure  $MTTF > 4 \times 10^6$  hours.
11. MTTF may be estimated by the expression  $MTTF \text{ (hours)} = A e^{\frac{B+C}{T+273}}$  where  $T$  is the channel temperature in degrees Celsius,  $A = 1.76$ ,  $B = -33.83$ , and  $C = 23,476$ .

### Thermal Characteristics <sup>12</sup>

Parameter	Test Conditions	Symbol	Typical	Units
Thermal Resistance using Finite Element Analysis	$V_{DS} = 48$ V, $T_C = 85^\circ\text{C}$ , $T_{CH} = 225^\circ\text{C}$	$R_{\theta}(\text{FEA})$	27.3	°C/W
Thermal Resistance using Infrared Measurement of Die Surface Temperature	$V_{DS} = 48$ V, $T_C = 85^\circ\text{C}$ , $T_{CH} = 225^\circ\text{C}$	$R_{\theta}(\text{IR})$	20.0	°C/W

12. Case temperature measured using thermocouple embedded in heat-sink. Contact local applications support team for more details on this measurement.

### Handling Procedures

Please observe the following precautions to avoid damage:

### Static Sensitivity

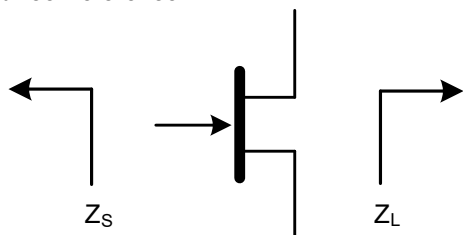
Gallium Nitride Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these HBM Class 1A, CDM Class 3 devices.

**Pulsed<sup>4</sup> Load-Pull Performance**  
Reference Plane at Device Leads

Frequency (GHz)	Z <sub>SOURCE</sub> (Ω)	Maximum Output Power					
		V <sub>DS</sub> = 48 V, I <sub>DQ</sub> = 20 mA, T <sub>C</sub> = 25°C, P2.5dB					
		Z <sub>LOAD</sub> <sup>13</sup> (Ω)	Gain (dB)	P <sub>OUT</sub> (dBm)	P <sub>OUT</sub> (W)	η <sub>D</sub> (%)	AM/PM (°)
2.3	50	55.1 + j40.2	15.1	38.9	7.8	58.3	-54.2
2.5	50	50.9 + j35.9	15.0	39.0	7.9	60.0	-79.3
2.7	50	44.9 + j30.1	14.9	38.8	7.6	60.7	-107.7

Frequency (GHz)	Z <sub>SOURCE</sub> (Ω)	Maximum Drain Efficiency					
		V <sub>DS</sub> = 48 V, I <sub>DQ</sub> = 20 mA, T <sub>C</sub> = 25°C, P2.5dB					
		Z <sub>LOAD</sub> <sup>14</sup> (Ω)	Gain (dB)	P <sub>OUT</sub> (dBm)	P <sub>OUT</sub> (W)	η <sub>D</sub> (%)	AM/PM (°)
2.3	50	36.3 + j64.9	16.7	37.9	6.0	72.2	-57.0
2.5	50	26.1 + j57.4	17.0	37.1	5.1	71.9	-78.3
2.7	50	21.1 + j50.7	16.8	36.7	4.7	73.8	-109.0

**Impedance Reference**

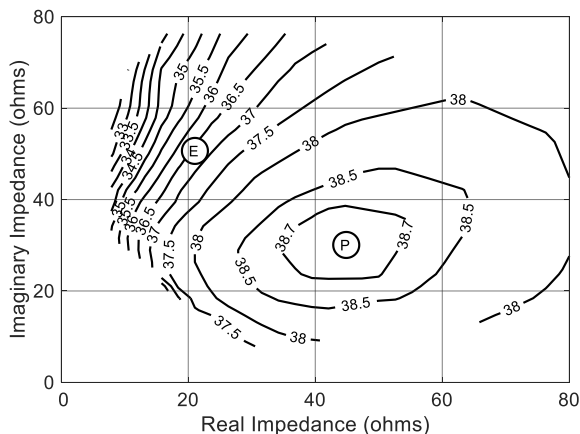


Z<sub>SOURCE</sub> = Measured impedance presented to the input of the device at package reference plane.  
Z<sub>LOAD</sub> = Measured impedance presented to the output of the device at package reference plane.

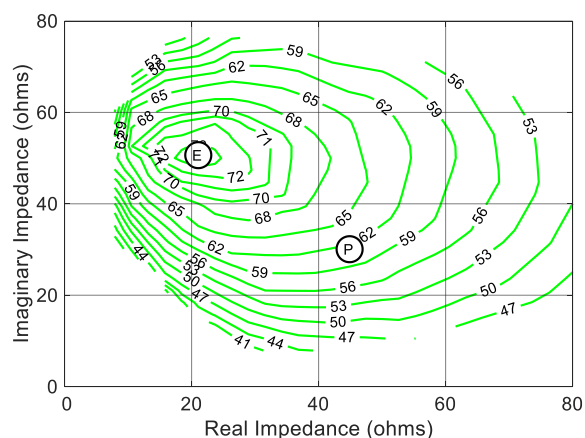
- 13. Load Impedance for optimum output power.
- 14. Load Impedance for optimum efficiency.

**Pulsed<sup>4</sup> Load-Pull Performance @ 2.7 GHz**

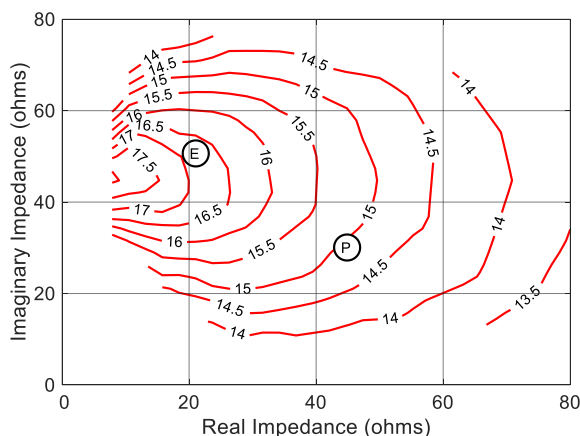
**P2.5dB Loadpull Output Power Contours (dBm)**



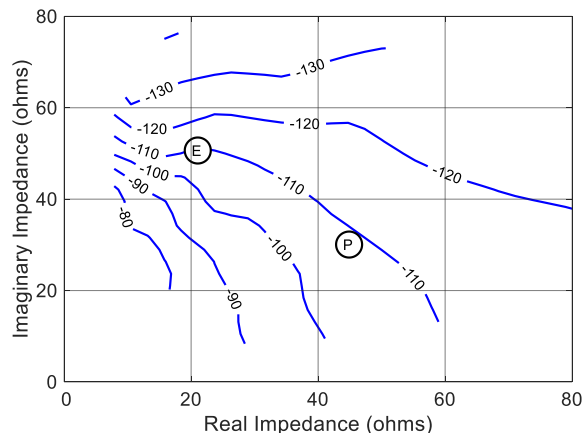
**P2.5dB Loadpull Drain Efficiency Contours (%)**



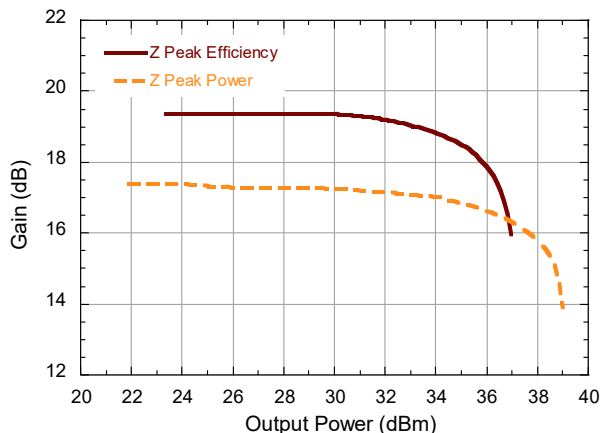
**P2.5dB Loadpull Gain Contours (dB)**



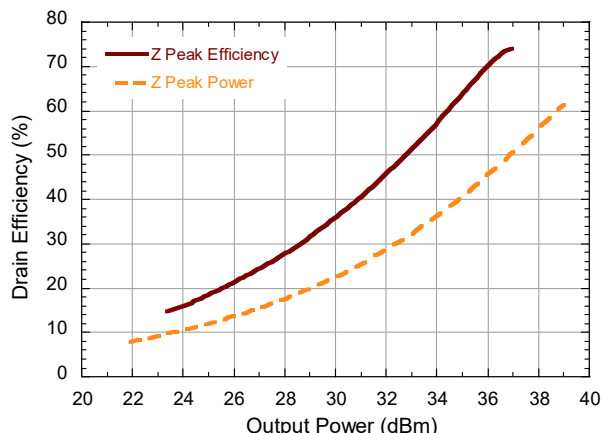
**P2.5dB Loadpull AM/PM Contours (°)**



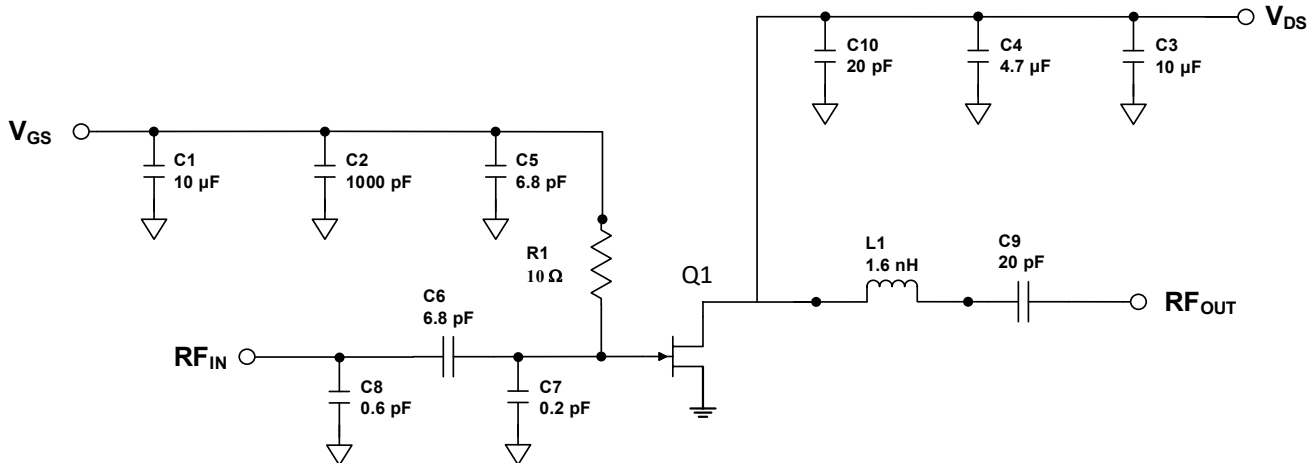
**Gain vs. Output Power**



**Drain Efficiency vs. Output Power**



Evaluation Test Fixture and Recommended Tuning Solution 2.3 - 2.7 GHz



**Description**

Parts measured on evaluation board (20-mil thick RO4350). Matching is provided using a combination of lumped elements and transmission lines as shown in the simplified schematic above. Recommended tuning solution component placement, transmission lines, and details are shown on the next page.

**Bias Sequencing**

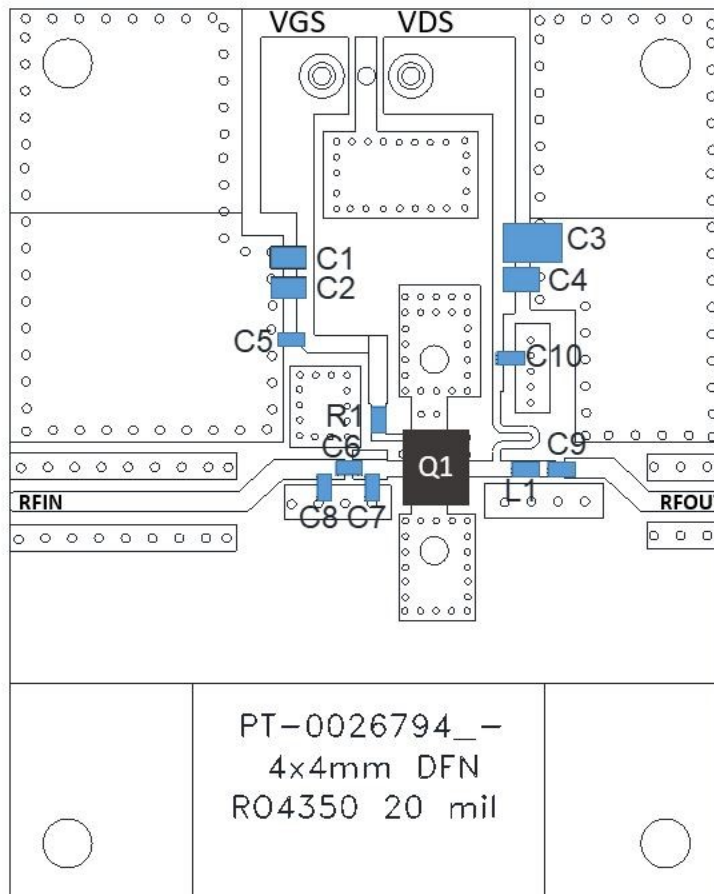
**Turning the device ON**

1. Set  $V_{GS}$  to pinch-off ( $V_P$ ).
2. Turn on  $V_{DS}$  to nominal voltage (48 V).
3. Increase  $V_{GS}$  until  $I_{DS}$  current is reached.
4. Apply RF power to desired level.

**Turning the device OFF**

1. Turn the RF power OFF.
2. Decrease  $V_{GS}$  down to  $V_P$  pinch-off.
3. Decrease  $V_{DS}$  down to 0 V.
4. Turn off  $V_{GS}$ .

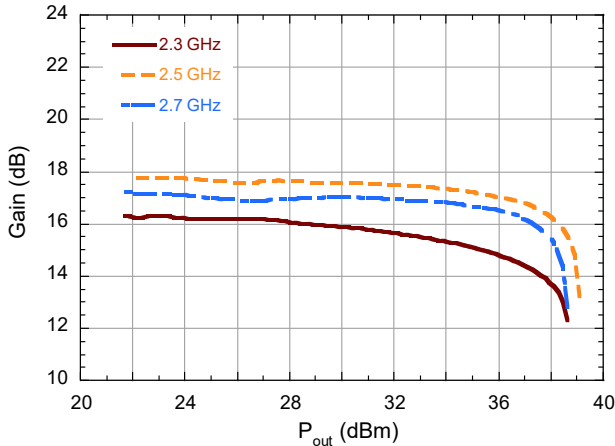
Evaluation Board and Recommended Tuning Solution 2.3 - 2.7 GHz



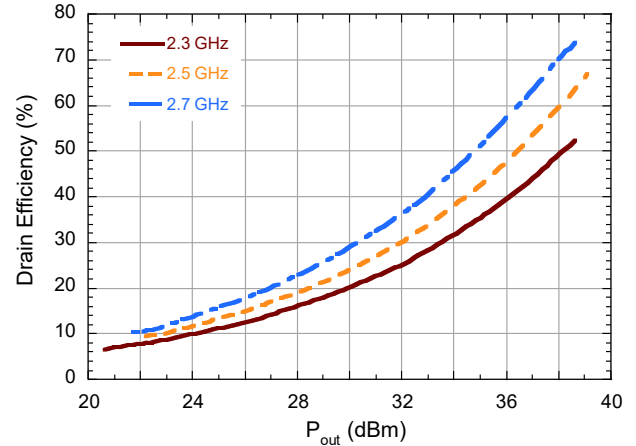
Reference Designator	Value	Tolerance	Manufacturer	Part Number
C1	10 $\mu$ F	+/- 20%	TDK Corporation	C2012X5R1C106M085AC
C2	1000 pF	+/- 10%	KEMET	C0805C102K2RACTU
C3	10 $\mu$ F	+/- 10%	Murata	GRM32EC72A106KE05L
C4	4.7 $\mu$ F	+/- 10%	Murata	GRM21BC81H475KE11L
C5, C6	6.8 pF	+/- 0.1pF	Murata	GQM1875C2E6R8BB12D
C7	0.2 pF	+/- 0.1pF	Murata	GQM1875C2ER20BB12D
C8	0.6 pF	+/- 0.1pF	Murata	GQM1875C2ER60BB12D
C9, C10	20 pF	+/- 5%	Murata	GQM1875C2E200JB12D
L1	1.6 nH	+/- 5%	Coilcraft	0603CS-1N6XJEW
R1	10 $\Omega$	+/- 0.5%	Yageo	RT0805DRE0710RL
PCB	RO4350, 20mil, 1oz Cu, Au Finish			

Typical Performance Curves as Measured in the 2.3 - 2.7 GHz Evaluation Board:  
 Pulsed<sup>4</sup> 2.7 GHz,  $V_{DS} = 48\text{ V}$ ,  $I_{DQ} = 20\text{ mA}$ ,  $T_C = 25^\circ\text{C}$  (Unless Otherwise Noted)

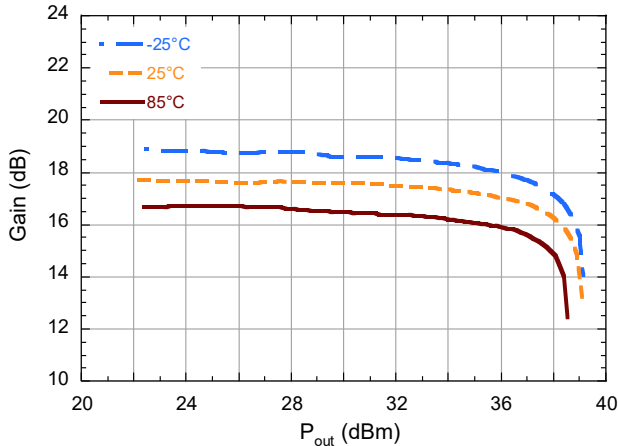
Gain vs. Output Power and Frequency



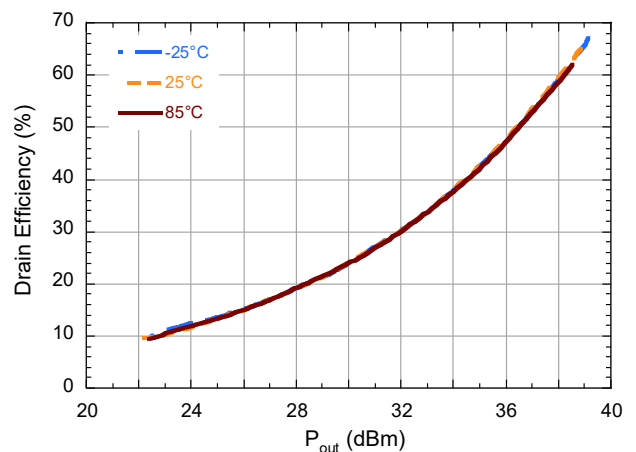
Drain Efficiency vs. Output Power and Frequency



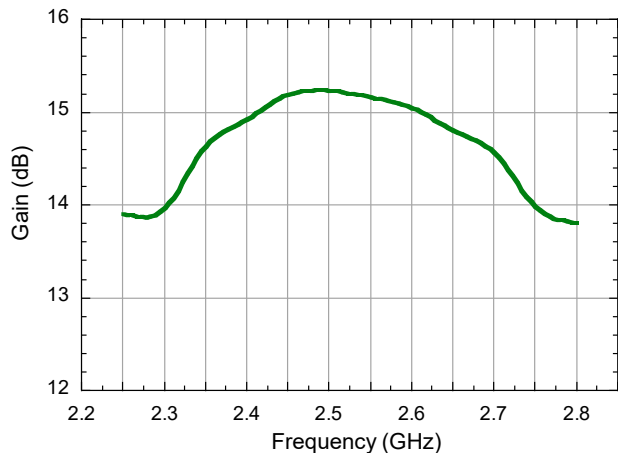
Gain vs. Output Power and  $T_C$



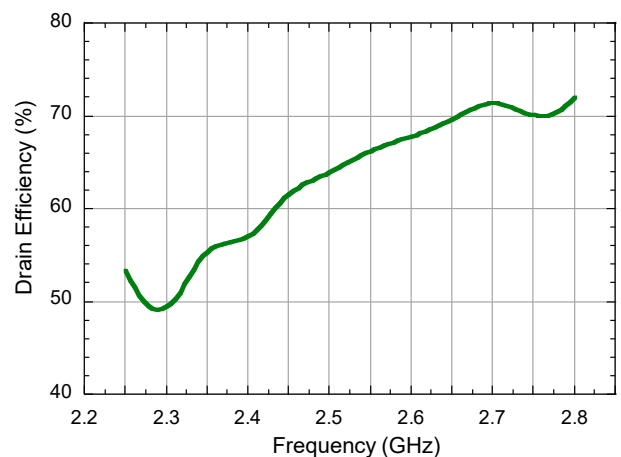
Drain Efficiency vs. Output Power and  $T_C$



Gain vs. Frequency, 2.5dB Gain Compression



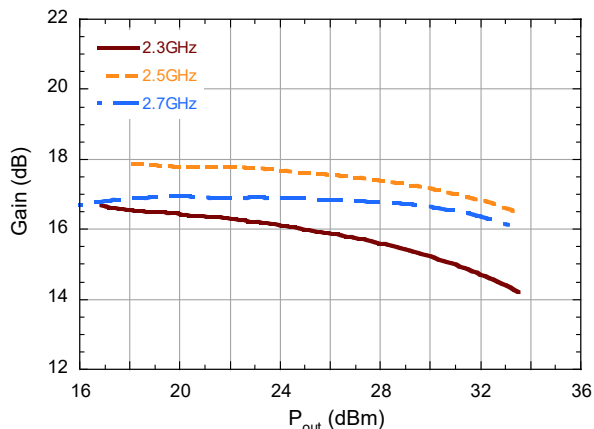
Drain Efficiency vs. Frequency, 2.5dB Gain Compression



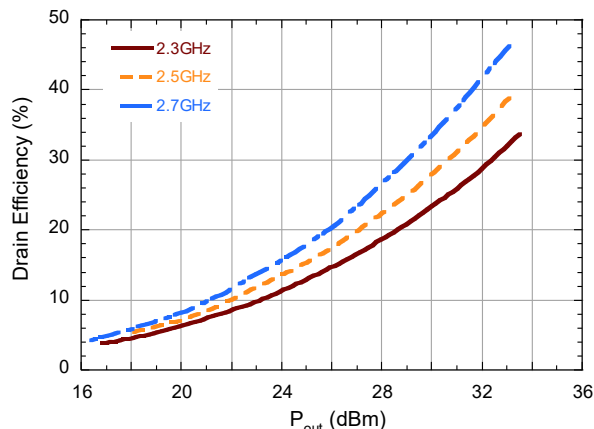


**Typical Performance as Measured in the 2.3 - 2.7 GHz Evaluation Board:**  
 WCDMA 3GPP TM1 64 DPCH 9.9 dB PAR @ 0.01% CCDF,  $V_{DS} = 48\text{ V}$ ,  $I_{DQ} = 20\text{ mA}$ ,  $T_C = 25^\circ\text{C}$

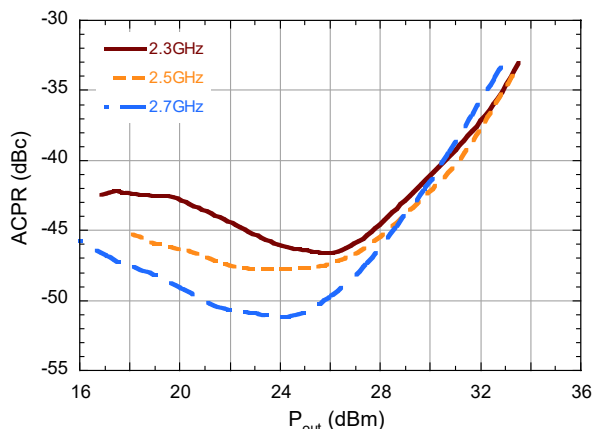
**Gain vs. Output Power and Frequency**



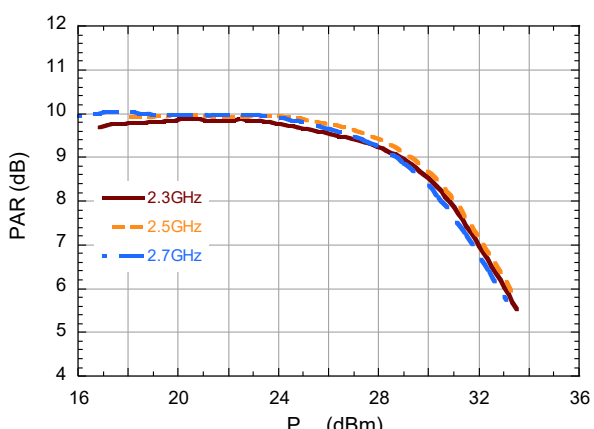
**Drain Efficiency vs. Output Power and Frequency**



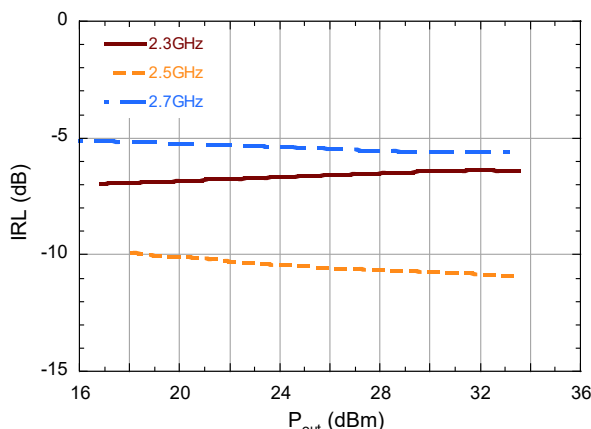
**ACPR (Max  $\pm 5\text{ MHz}$ ) vs. Output Power and Frequency**



**PAR (CCDF @ 0.01%) vs. Output Power and Frequency**

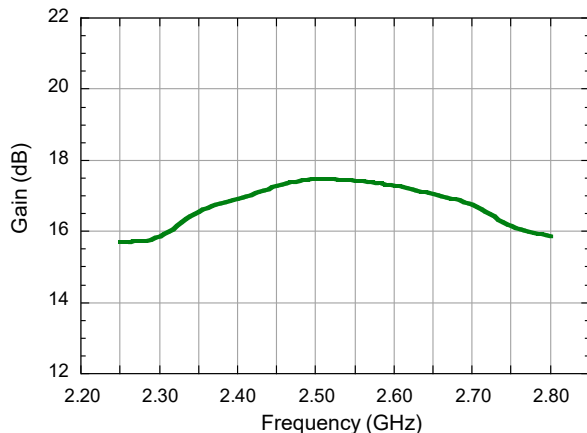


**Input Return Loss vs. Output Power and Frequency**

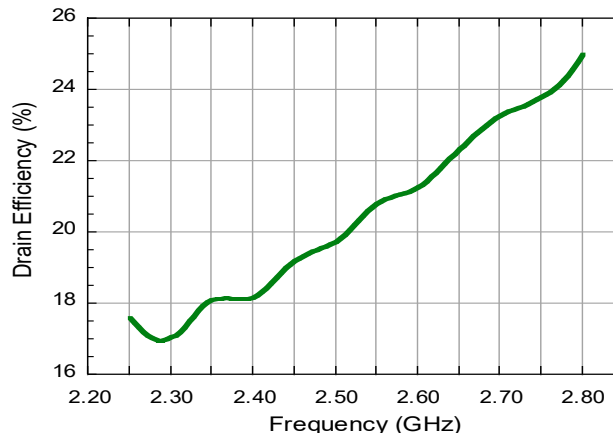


**Typical Performance as Measured in the 2.3 - 2.7 GHz Evaluation Board:  
WCDMA 3GPP TM1 64 DPCH 9.9 dB PAR @ 0.01% CCDF,  $V_{DS} = 48\text{ V}$ ,  $I_{DQ} = 20\text{ mA}$ ,  $T_C = 25^\circ\text{C}$**

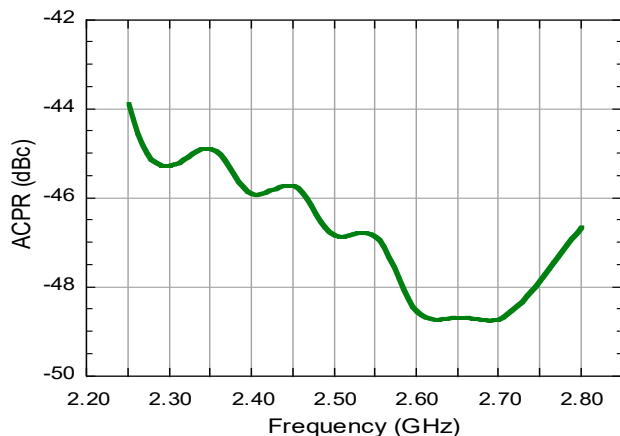
**Gain vs. Frequency at  $P_{OUT} = 27\text{ dBm}$**



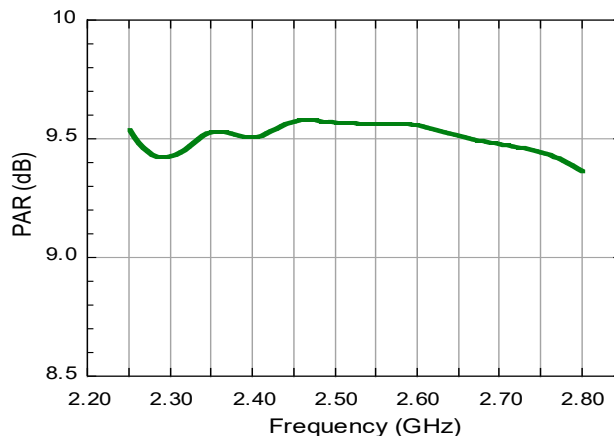
**Drain Efficiency vs. Frequency at  $P_{OUT} = 27\text{ dBm}$**



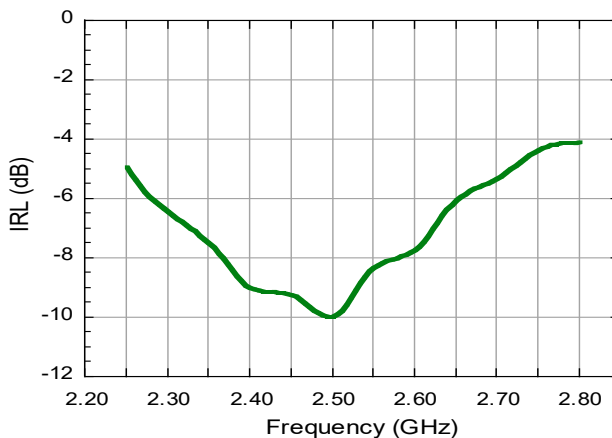
**ACPR (Max  $\pm 5\text{ MHz}$ ) vs. Frequency at  $P_{OUT} = 27\text{ dBm}$**



**PAR (CCDF @ 0.01%) vs. Frequency at  $P_{OUT} = 27\text{ dBm}$**



**Input Return Loss vs. Frequency at  $P_{OUT} = 27\text{ dBm}$**



# GaN Amplifier 48 V, 8 W

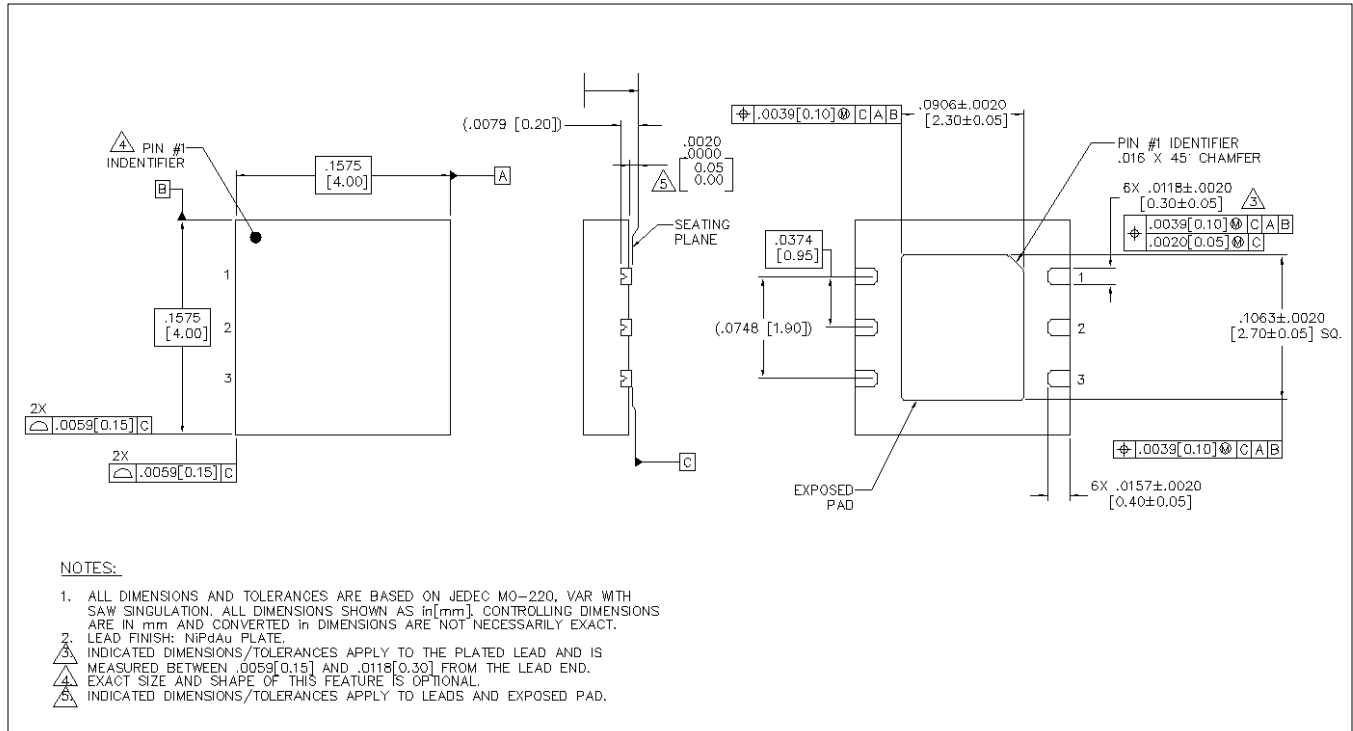
## 2.3 - 2.7 GHz



MAGB-102327-010B0P

Rev. V1

### Lead-Free 4 x 4 mm 6-Lead Package Dimensions<sup>†</sup>



<sup>†</sup> Reference Application Note S2083 for lead-free solder reflow recommendations.  
Meets JEDEC moisture sensitivity level (MSL) 3 requirements.

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